



# Specification for Approval

Date: 2013/03/15

天河 Customer:

	TAI-TECH P/N:	FPI0705F-SERIES							
	CUSTOMER P/N:								
	DESCRIPTION:								
	QUANTITY:	pcs							
REMARK:									
	Cu	stomer Approval Feedba	ck						

西北臺慶科技股份有限公司 **TAI-TECH Advanced Electronics Co., Ltd** 

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Mike Yang	Peijun Lo	Shelly Hsu

**TAI-TECH** 

# SMD Type Power Inductor

FPI0705F-SERIES

	ECN HISTORY LIST						
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN		
1.0	13/03/15	新 發 行	楊祥忠	羅培君	徐允珮		
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備							
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# **SMD Type Power Inductor**

FPI0705F-SERIES

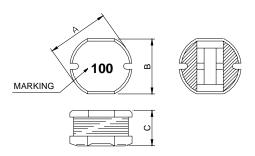
### 1. Features

- 1.Excellent solderability and high heat resistance.
- 2. Excellent terminal strength construction.
- 3. Packed in embossed carrier tape and can be used by automatic mounting machine.
- 4.100% Lead(Pb) & Halogen-Free and RoHS compliant.





#### 2. Dimension



Size	A(mm)	B(mm)	C(mm)
FPI 0705	7.80±0.3	7.00±0.3	5.00±0.3

### 3. Part Numbering



A: Series

B: Dimension

C: Lead free type

D: Inductance 100=10uH, 101=100uH E: Inductance Tolerance  $K=\pm 10\%$ ,  $M=\pm 20\%$ 

### 4. Specification

Customer Part Number	TAI-TECH Part Number	Inductance (uH)	Tolerance (%)	Test Frequency (Hz)	DCR (Ω) max.	IDC (A) max.
	FPI 0705F-100M	10	± 20%	1V/2.52M	0.07	2.30
©	FPI 0705F-120M	12	± 20%	1V/2.52M	0.08	2.00
	FPI 0705F-150M	15	± 20%	1V/2.52M	0.09	1.80
	FPI 0705F-180M	18	± 20%	1V/2.52M	0.10	1.60
	FPI 0705F-220M	22	± 20%	1V/2.52M	0.11	1.50
©	FPI 0705F-270M	27	± 20%	1V/2.52M	0.12	1.30
	FPI 0705F-330M	33	± 20%	1V/2.52M	0.13	1.20
	FPI 0705F-390M	39	± 20%	1V/2.52M	0.16	1.10
©	FPI 0705F-470K	47	± 10%	1V/2.52M	0.18	1.10
	FPI 0705F-560K	56	± 10%	1V/2.52M	0.24	0.94
	FPI 0705F-680K	68	± 10%	1V/2.52M	0.28	0.85
	FPI 0705F-820K	82	± 10%	1V/2.52M	0.37	0.78
	FPI 0705F-101K	100	± 10%	1V/1K	0.43	0.72

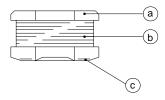
Customer Part Number	TAI-TECH Part Number	Inductance (uH)	Tolerance (%)	Test Frequency (Hz)	DCR (Ω) max.	IDC (A) max.
	FPI 0705F-121K	120	± 10%	1V/1K	0.47	0.66
	FPI 0705F-151K	150	± 10%	1V/1K	0.64	0.58
	FPI 0705F-181K	180	± 10%	1V/1K	0.71	0.51
	FPI 0705F-221K	220	± 10%	1V/1K	0.96	0.49
	FPI 0705F-271K	270	± 10%	1V/1K	1.11	0.42
	FPI 0705F-331K	330	± 10%	1V/1K	1.26	0.40
	FPI 0705F-391K	390	± 10%	1V/1K	1.77	0.36
	FPI 0705F-471K	470	± 10%	1V/1K	1.96	0.34

### \* IDC Test

For the parts with inductance under 82~uH, the L is measured at 1MHz then when a IDC current is applied, the L should drop less than 35%. For the parts with inductance over 100~uH, the L is measured at 1KHz then when a IDC current is applied, the L should drop less than 35%.

For all FPI series ,when a IDC current is applied, the temperature rised of the parts is less than 40 degree C

### 5. Material List



No.	Item	Material
1	Core	Ferrite DR Core
2	Wire	Enamelled Copper wire(155°C Class)
3	Terminal	Ag+Ni+Sn

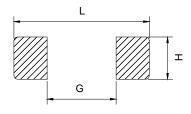
### 6. Schematic Diagram



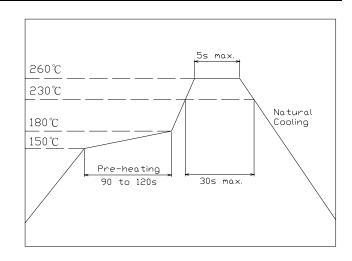
## 7. Reliability and Test Condition

Item	Performance	Test Condition
Operating Temperature	-25~+85℃	
Storage temperature	-25~+85°C (For products in unopened tape package, less than 40°C)	
Rated Current	Base on temp. rise & △L/LOA≦35%	
Temperature Rise Test	40°C typ. (∆t)	
Solderability	More than 90% of the terminal electrode shall be covered with fresh solder.	Preheat: 150±25°C for 60 secs Solder: Sn-Ag3.0-Cu0.5 Solder Temp::245±5°C Flux: Rosin Dip Time: 4±1 secs
Thermal Shock Test (Temp. Cycle) MIL-STD-202G METHOD 107	Inductance shall not change more than ±10%	ROOM TEMP.   −55±2°C     30 MINUTES
Humidity Resistance Test MIL-STD-202G METHOD 103	Inductance shall not change more than ±10%	Temperature: 40±2°C Humidity: 90–95% Applied Current: per spec. Time: 500±8 hrs
High Temperature Resistance Test MIL-STD-202G METHOD 108	Inductance shall not change more than ±10%	Temperature: 85±2°C Applied Current: per spec. Time: 500±8 hrs
Random Vibration Test	Appearance: Cracking, shipping and any other defects harmful to the characteristics should not be allowed.  Inductance: within±30%	Frequency: 10-55-10Hz for 1 min.  Amplitude: 1.52mm  Directions and times: X, Y, Z directions for 2 hours.  A period of 2 hours in each of 3 mutually perpendicular directions (Total 6 hours).

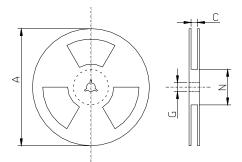
### 8. Recommended PC Board Pattern



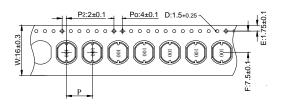
L(mm)	G(mm)	H(mm)
8.0	2.0	7.5



### 9. Packaging Information



Style	A(mm)	C(mm)	G(mm)	N(mm)
13"X16mm	330	18 <sup>+0</sup>	13.5±0.5	50 <sup>-0</sup>



Style	W(mm)	P(mm)	D(mm)	Packaging Qty(pcs)
16 mm	16±0.3	12±0.1	1.5±0.25	1,000

### **Application Notice**

· Storage Conditions

To maintain the solderability of terminal electrodes:

- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1
- 2. Recommended products should be used within 12 months form the time of delivery.
- 3. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.





# **Test Report**

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西北臺慶科技股份有限公司 / TAI-TECH ADVANCED ELECTRONICS CO., LTD.

(東莞臺慶精密電子有限公司 / TAI-TECH ADVANCED ELECTRONICS (DONGGUAN) CO. LTD.)

(臺廣精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

桃園縣楊梅市幼獅工業區幼四路1之1號 / NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI CITY, TAO-YUAN HSIEN. TAIWAN R. O. C.)

(廣東省東莞市黄江鎮黄牛埔福祥街2號 / NO. 2, FUXIANG STREET, HUANGNIUPU, HUANGJIANG TOWN, DONGGUAN, GUANGDONG) (江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 / GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

以下測試樣品係由客户送樣,且由客户聲稱並經客户確認如下 (The following samples was/were submitted and identified by/on behalf of the client as):

樣品名稱(Sample Description)

WINDING POWER INDUCTOR, SMD POWER INDUCTOR

樣品型號(Style/Item No.)

LQC, LQN, FPI, FPIP, FPIG SERIES

收件日期(Sample Receiving Date)

2012/05/24

測試期間(Testing Period)

2012/05/24 TO 2012/05/31

測試結果(Test Results)

: 請見下一頁 (Please refer to next pages).



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# **Test Report**

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#### 測試結果(Test Results)

測試部位(PART NAME) No.1 :

整體混測(5款) (MIXED ALL PARTS(5 TYPES))

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
病 / Cadmium (Cd)	mg/kg	參考IEC 62321: 2008方法, 以感應耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321: 2008 and performed by ICP-AES.	2	n.d.
鉛 / Lead (Pb)	mg/kg	參考IEC 62321: 2008方法, 以感 應耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321: 2008 and performed by ICP-AES.	2	n.d.
汞 / Mercury (Hg)	mg/kg	参考IEC 62321: 2008方法, 以感 應耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321: 2008 and performed by ICP-AES.	2	n.d.
六價鉻 / Hexavalent Chromium Cr(VI)	mg/kg	參考IEC 62321: 2008方法,以UV-VIS檢測. / With reference to IEC 62321: 2008 and performed by UV-VIS.	2	n.d.
鹵素 / Halogen				
鹵素(氟)/ Halogen-Fluorine (F) (CAS No.: 14762-94-8)			50	n.d.
鹵素(氣)/ Halogen-Chlorine (CI) (CAS No.: 22537-15-1)	mg/kg	參考BS EN 14582:2007, 以離子層 析儀分析. / With reference to	50	n.d.
鹵素(溴)/ Halogen-Bromine (Br) (CAS No.: 10097-32-2)		BS EN 14582:2007. Analysis was performed by IC.	50	n.d.
鹵素(碘)/ Halogen-Iodine(I) (CAS No.: 14362-44-8)			50	n.d.

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# 測試報告 **Test Report**

號碼(No.) : CE/2012/54920 日期(Date) : 2012/05/31 頁數(Page) : 3 of 8

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
多溴聯苯總和 / Sum of PBBs			-	n.d.
一溴聯苯 / Monobromobiphenyl			5	n.d.
二溴聯苯 / Dibromobiphenyl	mg/kg	參考IEC 62321: 2008方法,以氣相層析/質譜儀檢測. / With reference to IEC 62321: 2008 and performed by GC/MS.	5	n.d.
三溴聯苯 / Tribromobiphenyl			5	n.d.
四溴聯苯 / Tetrabromobiphenyl			5	n.d.
五溴聯苯 / Pentabromobiphenyl			5	n.d.
六溴聯苯 / Hexabromobiphenyl			5	n.d.
七溴聯苯 / Heptabromobiphenyl			5	n.d.
八溴聯苯 / Octabromobiphenyl			5	n.d.
九溴聯苯 / Nonabromobiphenyl			5	n.d.
十溴聯苯 / Decabromobiphenyl			5	n.d.
多溴聯苯醚總和 / Sum of PBDEs			-	n.d.
一溴聯苯醚 / Monobromodiphenyl ether			5	n.d.
二溴聯苯醚 / Dibromodiphenyl ether			5	n.d.
三溴聯苯醚 / Tribromodiphenyl ether			5	n.d.
四溴聯苯醚 / Tetrabromodiphenyl ether			5	n.d.
五溴聯苯醚 / Pentabromodiphenyl ether			5	n.d.
六溴聯苯醚 / Hexabromodiphenyl ether			5	n.d.
七溴聯苯醚 / Heptabromodiphenyl ether			5	n.d.
八溴聯苯醚 / Octabromodiphenyl ether			5	n.d.
九溴聯苯醚 / Nonabromodiphenyl ether			5	n.d.
十溴聯苯醚 / Decabromodiphenyl ether			5	n.d.

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#### 備註(Note):

- 1. mg/kg = ppm ; 0.1wt% = 1000ppm
- 2. n.d. = Not Detected (未檢出)
- 3. MDL = Method Detection Limit (方法偵測極限値)
- 4. "-" = Not Regulated (無規格值)
- 5. 樣品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個别單一材質的含量. (The samples was/were analyzed on behalf of the applicant as mixing sample in one testing. The above results was/were only given as the informality value.)

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### **Test Report**

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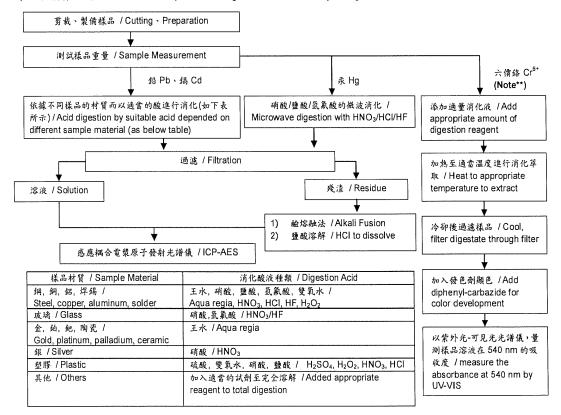
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- 1) 根據以下的流程圖之條件,樣品已完全溶解。( 六價鉻測試方法除外 ) / These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cr<sup>6+</sup> test method excluded)
- 2) 测试人员:楊登偉 / Name of the person who made measurement: Climbgreat Yang
- 3) 測試負責人:張啓興 / Name of the person in charge of measurement: Troy Chang



Note\*\*:(1) 針對非金屬材料加入鹼性消化液,加熱至 90~95℃ 萃取. / For non-metallic material, add alkaline digestion reagent and heat to 90~95℃

(2) 針對金屬材料加入純水,加熱至沸騰萃取. / For metallic material, add pure water and heat to boiling.

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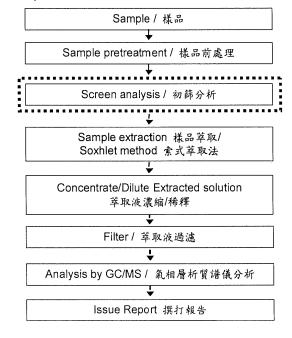
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#### 多溴聯苯/多溴聯苯醚分析流程圖 / PBB/PBDE analytical FLOW CHART

- 測試人員:翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人:張啓興 / Name of the person in charge of measurement: Troy Chang

初次測試程序 / First testing process -選擇性篩檢程序 / Optional screen process \*\*\*\*\*\*\*

確認程序 / Confirmation process - · - · ▶



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# 測試報告 **Test Report**

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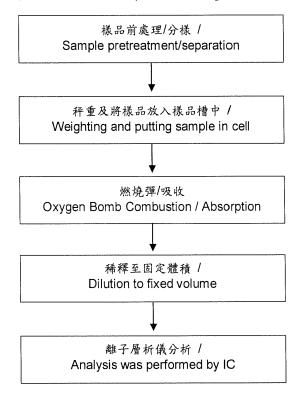
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### 鹵素分析流程圖 / Analytical flow chart of halogen content

- 測試人員: 陳恩臻 / Name of the person who made measurement: Rita Chen
- 測試負責人:張啓興 / Name of the person in charge of measurement: Troy Chang



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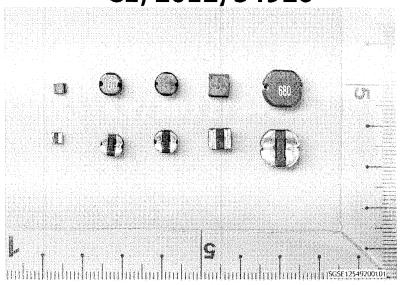
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\* 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. \*

(The tested sample / part is marked by an arrow if it's shown on the photo.)

CE/2012/54920



報告結尾(End of Report) \*\*

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